

### DATA SHEET

# SKY67183-396LF: 400 to 6000 MHz Broadband Low-Noise Amplifier

#### **Applications**

- FDD and TDD 4G LTE and 5G NR systems
- Active antenna array and massive MIMO
- Receive LNA for micro-cell, macro-cell, and small-cell base stations
- Land mobile radios and military communications
- · Low-noise broadband gain block and driver amplifier

#### **Features**

- Low-noise amplifier:
  - Very low noise figure
  - $-\,$  Temperature and process-stable active bias up to +115  $^{\circ}\text{C}$
  - Wide operating voltage range
  - $-\,$  Low gain slope over operating band
  - Excellent input return loss
- Integrated controller:
  - Stable amplifier bias
  - Temperature compensation
- True logic level thresholds
- Fast response time
- · Excellent broadband flat gain performance
- Minimal BOM count
- Low current IDD 56 mA @ 5 V
- Fast rise/fall time ENABLE function suitable for TDD application
- Miniature DFN (8-pin, 2 x 2 mm) package (MSL1 @ 260 °C per JEDEC J-STD-020)



Skyworks Green<sup>™</sup> products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*<sup>™</sup>, document number SQ04–0074.

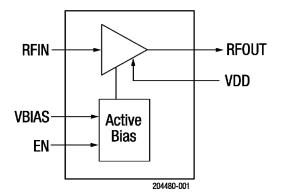


Figure 1. SKY67183-396LF Block Diagram

#### **Description**

The SKY67183-396LF is a wide-band low-noise amplifier with superior gain flatness and exceptional linearity.

The compact 2 x 2 mm, 8-pin Dual Flat No Lead packaged LNA is designed for FDD and TDD 4G LTE and 5G NR infrastructure systems operating from 400 to 6000 MHz.

The internal active bias circuitry provides stable performance over temperature and process variation.

A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

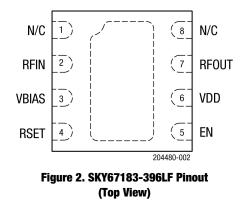


Table 1. SKY67183-396LF Signal Descriptions

| Pin | Name  | Description  |  | Name  | Description  |
|-----|-------|--|--|-------|--|
| 1   | N/C   | No connection (may be connected to ground with no change in performance) |  | EN    | Enable voltage to LNA  |
| 2   | RFIN  | RF input (DC blocking capacitor required)                                |  | VDD   | VDD voltage to LNA   |
| 3   | VBIAS | Bias voltage for input gate  |  | RFOUT | RF output. DC blocking capacitor is required.                            |
| 4   | RSET  | External resistor to set bias current                                    |  | N/C   | No connection (may be connected to ground with no change in performance) |

#### **Electrical and Mechanical Specifications**

The absolute maximum ratings of the SKY67183-396LF are provided in Table 2. Recommended operating conditions are shown in Table 3. Thermal data is shown in Table 4.

Electrical specifications are provided in Tables 5 and 6.

#### Table 2. SKY67183-396LF Absolute Maximum Ratings<sup>1</sup>

| Parameter  | Symbol | Minimum | Maximum     | Units  |
|--|--------|---------|-------------|--------|
| Supply voltage   | Vdd    |         | 5.5         | V      |
| LNA enable   | EN     | -0.5    | 2.8         | V      |
| Quiescent supply current   | Ισα    |         | 100         | mA     |
| RF input power (C/W)   | Pin    |         | +22         | dBm    |
| Storage temperature  | Tstg   | -40     | +150        | °C     |
| Operating temperature  | Та     | -40     | +115        | °C     |
| Junction temperature   | TJ     |         | +150        | °C     |
| Electrostatic discharge:   | ESD    |         |             |        |
| Charged Device Model (CDM), Class C3<br>Human Body Model (HBM), Class 1A |        |         | 1000<br>250 | V<br>V |

1 Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

**ESD HANDLING**: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.

#### Table 3. SKY67183-396LF Recommended Operating Conditions

| Parameter         | Symbol | Min  | Тур | Мах  | Units |
|-------------------|--------|------|-----|------|-------|
| Supply voltage    | VDD    | 3.3  | 5.0 | 5.25 | ۷     |
| LNA enable:<br>ON | EN     |      | 0   | 0.63 | V     |
| OFF               |        | 1.17 | 1.8 | 2.4  | V     |

#### Table 4. SKY67183-396LF Electrical Specifications: Thermal Data<sup>1</sup>

#### **Test Condition** Parameter Symbol Min Тур Max Units Thermal resistance θJC 90 °C/W Channel temperature @ +105 °C reference ΤJ VDD = 5.25 V, IDQ = 60 mA, RF applied, dissipated power = 0.29 W°C (package heat slug) 130

#### (VDD = 5.25 V, Enable = GND, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50 $\Omega$ , Unless Otherwise Noted)

<sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

# Table 5. SKY67183-396LF Electrical Specifications: 4200 to 4900 MHz Optimized BoM in Table 8<sup>1</sup>

### (VDD = 5.0 V, Enable = GND, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50 $\Omega$ , f = 4500 MHz, Unless Otherwise Noted)

| Parameter  | Symbol     | Test Condition                         | Min  | Тур                  | Max               | Units             |
|--|------------|--|------|----------------------|-------------------|-------------------|
| RF Specifications  |            |  |      |                      |                   |                   |
| Noise figure   | NF         | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz |      | 0.5<br>0.5<br>0.6    | 1.0<br>1.0<br>1.1 | dB<br>dB<br>dB    |
| Small signal gain  | IS211      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | 16.5 | 18.2<br>18.2<br>17.7 |                   | dB<br>dB<br>dB    |
| Input return loss  | IS11I      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | 12   | 16.1<br>32.8<br>21.9 |                   | dB<br>dB<br>dB    |
| Output return loss   | IS22I      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | 10   | 11.2<br>23.2<br>14.9 |                   | dB<br>dB<br>dB    |
| Reverse isolation  | IS12I      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | 26   | 32<br>32<br>32       |                   | dB<br>dB<br>dB    |
| Third order output intercept<br>(-20 dBm input/1 MHz tone)             | 0IP3       | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | +27  | +29<br>+29<br>+28.5  |                   | dBm<br>dBm<br>dBm |
| 1 dB output compression point  | OP1dB      | @ 4200 MHz<br>@ 4500 MHz<br>@ 4900 MHz | +16  | +20<br>+19<br>+20    |                   | dBm<br>dBm<br>dBm |
| DC Specifications  |            |  |      |                      |                   |                   |
| Supply voltage   | Vdd        |  |      | 5.0                  |                   | V                 |
| Quiescent current  | IDD        |  | 45   | 56                   | 67                | mA                |
| Settling time 0.3 dB <sup>2</sup><br>Settling time 0.1 dB <sup>3</sup> | TS1<br>TS2 | @ 4500 MHz                             |      | 0.3<br>0.31          | 0.9<br>0.9        | us<br>us          |

<sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

<sup>2</sup> Settling time 0.3 dB is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power achieves within 0.3 dB of the average steady-state "on" level.

<sup>3</sup> Settling time 0.1 dB is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power achieves within 0.1 dB of the average steady-state "on" level.

#### Typical Performance Characteristics 4200 to 4900 MHz (VDD = 5 V, PIN = -20 dBm, Characteristic Impedance [Zo] = 50 $\Omega$ , Unless Otherwise Noted)

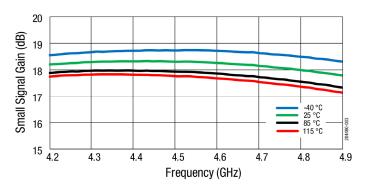


Figure 3. Small Signal Gain (dB) vs Frequency (GHz)

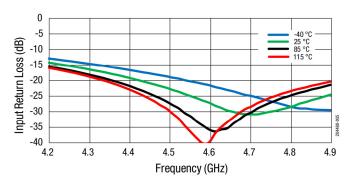


Figure 5. Input Return Loss (dB) vs Frequency

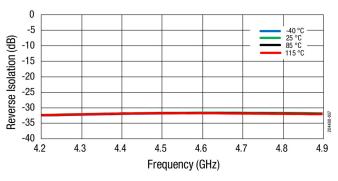
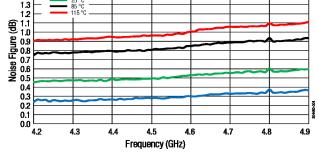
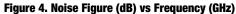


Figure 7. Reverse Isolation (dB) vs Frequency (GHz)





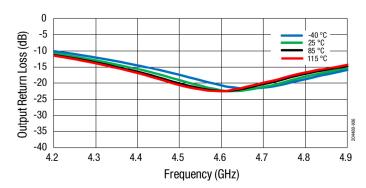


Figure 6. Output Return Loss (dB) vs Frequency

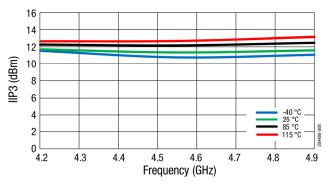


Figure 8. IIP3 (dBm) vs Frequency (GHz)

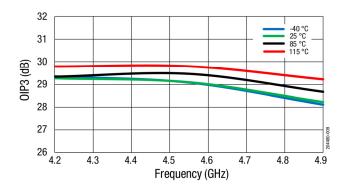


Figure 9. OIP3 (dBm) vs Frequency (GHz)

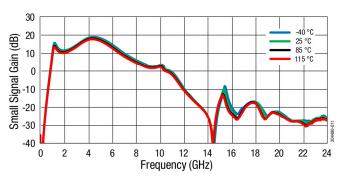


Figure 11. Small Signal Gain (dB) vs Frequency (GHz)

0

-10

-20 -30 -40 -50

-60

-70

-80

0 2 4 6 8 10 12 14 16 18 20 22 24

Reverse Isolation (dB)

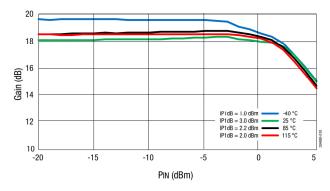


Figure 10. Gain (dB) vs PIN (dBm)

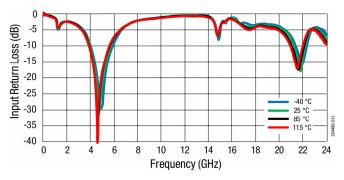


Figure 12. Input Return Loss (dB) vs Frequency (GHz)

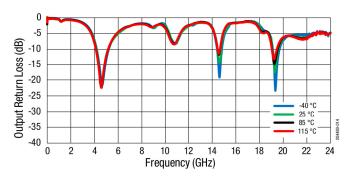
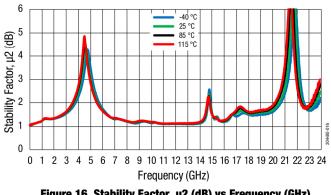
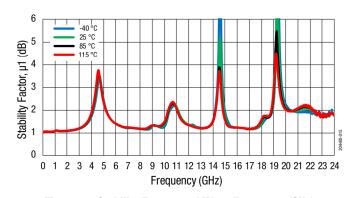


Figure 14. Output Return Loss (dB) vs Frequency (GHz)





Frequency (GHz)

Figure 13. Reverse Isolation (dB) vs Frequency (GHz)

Figure 15. Stability Factor, µ1 (dB) vs Frequency (GHz)

Figure 16. Stability Factor, µ2 (dB) vs Frequency (GHz)

Skyworks Solutions, Inc. • Phone [781] 376-3000 • Fax [781] 376-3100 • sales@skyworksinc.com • www.skyworksinc.com 2044801 • Skyworks Proprietary Information • Products and Product Information are Subject to Change Without Notice • February 9, 2021

-40 °C

25 °C 85 °C

115 °C

| Parameter  | Symbol     | Test Condition   | Min | Тур                     | Max | Units             |
|--|------------|--|-----|-------------------------|-----|-------------------|
| RF Specifications                                    |            |  |     |                         |     |                   |
| Noise figure   | NF         | @ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   |     | 0.43<br>0.44<br>0.48    |     | dB<br>dB<br>dB    |
| Gain   | S21        | @ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   |     | 19.2<br>19.1<br>18.9    |     | dB<br>dB<br>dB    |
| Input return loss                                    | IS11I      | @ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   |     | 15<br>21.3<br>31.2      |     | dB<br>dB<br>dB    |
| Output return loss                                   | S22        | @ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   |     | 11.6<br>16.3<br>19.9    |     | dB<br>dB<br>dB    |
| Reverse isolation                                    | IS12I      | @ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   |     | 32.9<br>32.4<br>32.1    |     | dB<br>dB<br>dB    |
| Third order output intercept point                   | OIP3       | PIN = -20 dBm, ∆ Tone = 1 MHz:<br>@ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz |     | +30.4<br>+28.9<br>+34.3 |     | dBm<br>dBm<br>dBm |
| 1 dB output compression point                        | OP1dB      | @ 3400 MHz<br>@ 3600 MHz<br>@ 3800 MHz                                   |     | +20.2<br>+20.1<br>+20.6 |     | dBm<br>dBm<br>dBm |
| DC Specifications                                    |            |  |     | •                       |     | •                 |
| Supply voltage                                       | Vdd        |  |     | 5.0                     |     | V                 |
| Quiescent current                                    | ldd        |  |     | 56                      |     | mA                |
| Settling time 0.3 $dB^2$<br>Settling time 0.1 $dB^3$ | Ts1<br>Ts2 | @ 3600 MHz   |     | 0.28<br>0.29            |     | us<br>us          |

## Table 6. SKY67183-396LF Electrical Specifications: 3400 to 3800 MHz Optimized BoM in Table 9<sup>1</sup>

(VDD = 5.0 V, Enable = GND, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

<sup>1</sup> Verified by characterization.

<sup>2</sup> Settling time 0.3 dB is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power achieves within 0.3 dB of the average steadystate "on" level.

<sup>3</sup> Settling time 0.1 dB is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power achieves within 0.1 dB of the average steadystate "on" level.

| Parameter  | Symbol     | Test Condition   | Min | Тур                     | Max | Units             |
|--|------------|--|-----|-------------------------|-----|-------------------|
| RF Specifications                                    |            | · ·  |     |                         |     |                   |
| Noise figure   | NF         | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   |     | 0.36<br>0.41<br>0.43    |     | dB<br>dB<br>dB    |
| Gain   | S21        | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   |     | 21.7<br>21.4<br>20.9    |     | dB<br>dB<br>dB    |
| Input return loss                                    | S11        | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   |     | 13<br>16.4<br>18.7      |     | dB<br>dB<br>dB    |
| Output return loss                                   | S22        | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   |     | 11.2<br>13.5<br>12.6    |     | dB<br>dB<br>dB    |
| Reverse isolation                                    | S12        | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   |     | 33.8<br>33.4<br>33.2    |     | dB<br>dB<br>dB    |
| Third order output intercept point                   | OIP3       | PIN = -20 dBm, ∆ Tone = 1 MHz:<br>@ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz |     | +32.2<br>+32.7<br>+33.4 |     | dBm<br>dBm<br>dBm |
| 1 dB output compression point                        | OP1dB      | @ 2300 MHz<br>@ 2500 MHz<br>@ 2700 MHz                                   |     | +19.5<br>+22<br>+22.1   |     | dBm<br>dBm<br>dBm |
| DC Specifications                                    |            |  |     |                         |     |                   |
| Supply voltage                                       | Vdd        |  |     | 5.0                     |     | V                 |
| Quiescent current                                    | ldd        |  |     | 56                      |     | mA                |
| Settling time 0.3 $dB^2$<br>Settling time 0.1 $dB^3$ | Ts1<br>Ts2 | @ 2500 MHz   |     | 0.3<br>0.33             |     | us<br>us          |

# Table 7. SKY67183-396LF Electrical Specifications: 2300 to 2700 MHz Optimized BoM in Table 101

(VDD = 5.0 V, Enable = GND, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

<sup>1</sup> Verified by characterization.

<sup>2</sup> Settling time 0.3 dB is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power achieves within 0.3 dB of the average steadystate "on" level.

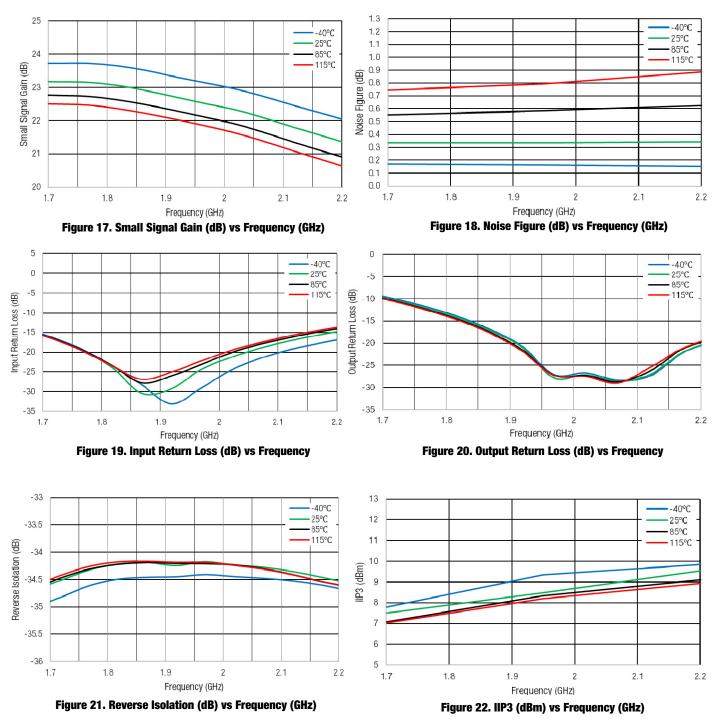
<sup>3</sup> Settling time 0.1 dB is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power achieves within 0.1 dB of the average steadystate "on" level.

| Parameter                          | Symbol     | Test Condition  | Min  | Тур   | Max  | Units |
|------------------------------------|------------|---|------|-------|------|-------|
| RF Specifications                  |            |   |      |       |      |       |
|                                    |            | @ 1700 MHz  |      | 0.34  | 0.75 | dB    |
| Noise figure                       | NF         | @ 1950 MHz  |      | 0.38  | 0.75 | dB    |
|                                    |            | @ 2200 MHz  |      | 0.41  | 0.85 | dB    |
|                                    |            | @ 1700 MHz  | 21.5 | 23.2  |      | dB    |
| Gain                               | IS211      | @ 1950 MHz  | 21   | 22.7  |      | dB    |
|                                    |            | @ 2200 MHz  | 19.5 | 21.5  |      | dB    |
|                                    |            | @ 1700 MHz  | 10   | 15.7  |      | dB    |
| Input return loss                  | IS11I      | @ 1950 MHz  | 10   | 26.2  |      | dB    |
|                                    |            | @ 2200 MHz  | 10   | 14.8  |      | dB    |
|                                    |            | @ 1700 MHz  | 7    | 9.7   |      | dB    |
| Output return loss                 | IS22I      | @ 1950 MHz  | 10   | 25.2  |      | dB    |
|                                    |            | @ 2200 MHz  | 10   | 20.6  |      | dB    |
|                                    |            | @ 1700 MHz  |      | 34.4  |      | dB    |
| Reverse isolation                  | IS12I      | @ 1950 MHz  |      | 34.2  |      | dB    |
|                                    |            | @ 2200 MHz  |      | 34.6  |      | dB    |
|                                    |            | $PIN = -20 \text{ dBm}, \Delta \text{ Tone} = 1 \text{ MHz}:$ |      |       |      |       |
| Third order output intercent point | 0IP3       | @ 1700 MHz  |      | +30.6 |      | dBm   |
| Third order output intercept point | UP3        | @ 1950 MHz  | 27   | +31.0 |      | dBm   |
|                                    |            | @ 2200 MHz  |      | +30.8 |      | dBm   |
|                                    |            | @ 1700 MHz  | 21.5 | +23.1 |      | dBm   |
| 1 dB output compression point      | 0P1dB      | @ 1950 MHz  | 21   | +22.5 |      | dBm   |
|                                    |            | @ 2200 MHz  | 19   | +21.3 |      | dBm   |
| DC Specifications                  |            |   |      |       |      |       |
| Supply voltage                     | Vdd        |   |      | 5     |      | V     |
| Quiescent current                  | ldd        |   |      | 56    |      | mA    |
| Settling time 0.3 dB <sup>2</sup>  | Ts1        | @ 1050 MU-  |      | 0.3   |      | us    |
| Settling time 0.1 dB <sup>3</sup>  | @ 1<br>Ts2 | @ 1950 MHz  |      | 0.33  |      | us    |

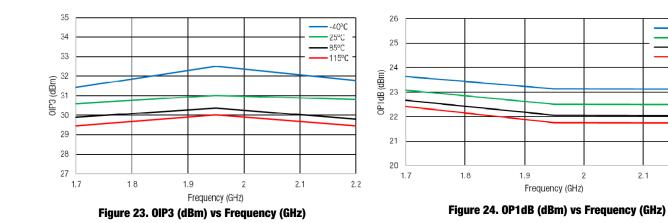
#### Table 8. SKY67183-396LF Electrical Specifications: 1700 to 2200 MHz Optimized BOM in Table 10<sup>1</sup> (VDD = 5.0 V. Enable = GND, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Z0] = 50 $\Omega$ , Unless Otherwise Noted)

<sup>2</sup> Settling time 0.3 dB is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power achieves within 0.3 dB of the average steady state "on" level.

<sup>3</sup> Settling time 0.1 dB is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power achieves within 0.1 dB of the average steady state "on" level.



#### Typical Performance Characteristics 1700 to 2200 MHz (VDD = 5 V, PIN = -20 dBm, Characteristic Impedance [Zo] = 50 $\Omega$ , Unless Otherwise Noted



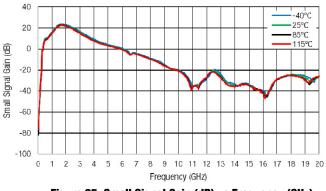


Figure 25. Small Signal Gain (dB) vs Frequency (GHz)

0 -10

-20

-30 -40

-50

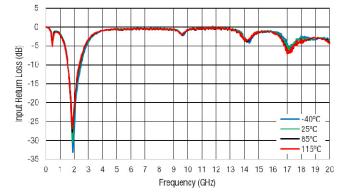
-60 -70

-80

-90

-100

Reverse Isolation (dB)



-40°C

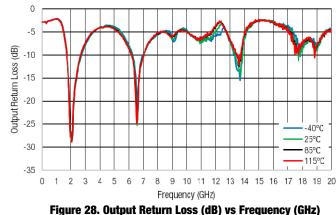
25°C

85°C

115°C

2.2

Figure 26. Input Return Loss (dB) vs Frequency (GHz)



s Frequency (GHz) Figure 28. Output Return I

-40°C

25°C

-85°C

115°C



0 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20

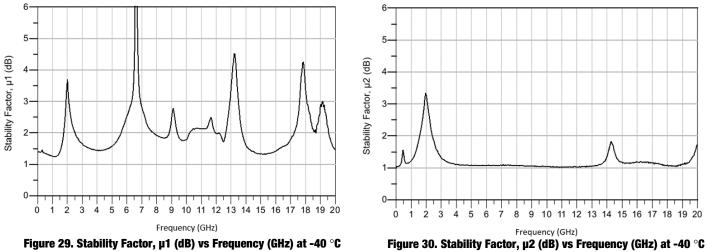


Figure 29. Stability Factor,  $\mu$ 1 (dB) vs Frequency (GHz) at -40 °C

#### **Evaluation Board Description**

The SKY67183-396LF Evaluation Board is used to test the performance of the SKY67183-396LF LNA. An Evaluation Board schematic diagram is provided in Figure 31. Table 9 lists the BOM for the Evaluation Board optimized for 4200 to 4900 MHz tuning. Table 10 lists the BOM for the Evaluation Board optimized for 3400 to 3800 MHz tuning.

Table 11 lists the Bill of Materials (BOM) for the Evaluation Board optimized for 2300 to 2700 MHz tuning. Table 12 lists the Bill of Materials (BOM) for the Evaluation Board optimized for 1700 to 2200 MHz tuning. An EVB assembly diagram is shown in Figure 32. EVB layout detail information is provided in Figure 33.

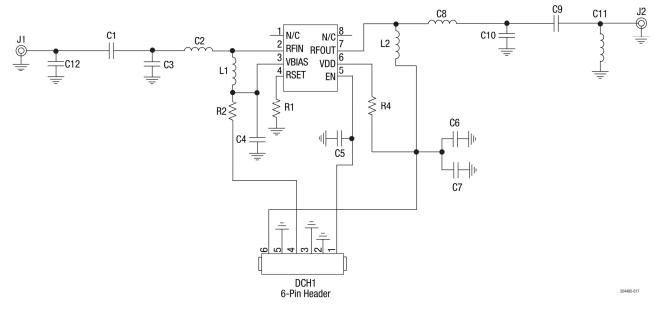


Figure 31. SKY67183-396LF Evaluation Board Schematic

| Component | Value  | Size  | Part Number        |
|-----------|--------|-------|--------------------|
| C1        | 1.8 pF | 0402  | GJM1555C1H1R8BB01D |
| C2        | 0.8 nH | 03015 | LQW04AN0N8C00D     |
| C3        | 0.4 pF | 0402  | GJM1555C1HR40WB01D |
| C4        | DNI    |       |                    |
| C5        | DNI    |       |                    |
| C6        | DNI    |       |                    |
| C7        | 4.7 uF | 0402  | GRM155C80J475MEAAD |
| C8        | 2.2 pF | 0402  | GRM1555C1H2R2BA01D |
| C9        | 0 Ω    | 0402  | Not critical       |
| C10       | 1.0 nH | 0402  | LQG15HS1N0S02D     |
| C11       | DNI    |       |                    |
| C12       | DNI    |       |                    |
| L1        | 18 nH  | 0402  | LQW15AN18NG8ZD     |
| L2        | 6.2 nH | 0402  | LQG15HS6N2S02D     |
| R1        | 8.2 kΩ | 0201  | Not critical       |
| R2        | DNI    |       |                    |
| R4        | 100 Ω  | 0201  | Not critical       |

| Component | Value  | Size | Part Number        |
|-----------|--------|------|--------------------|
| C1        | 1.8 pF | 0402 | GJM1555C1H1R8BB01  |
| C2        | 1.8 nH | 0402 | LQW15AN1N8C00      |
| C3        | 0.4 pF | 0402 | GJM1555C1HR40WB01D |
| C4        | DNI    |      |                    |
| C5        | DNI    |      |                    |
| C6        | DNI    |      |                    |
| C7        | 4.7 uF | 0402 | GRM155C80J475MEAAD |
| C8        | 5.6 pF | 0402 | GRM1555C1H5R6BA01D |
| C9        | 0 Ω    | 0402 | Not critical       |
| C10       | 1.8 nH | 0402 | LQG15HS1N8S02D     |
| C11       | DNI    |      |                    |
| C12       | DNI    |      |                    |
| L1        | 12 nH  | 0402 | LQW15AN12NG8ZD     |
| L2        | 5.6 nH | 0402 | LQG15HS5N6S02D     |
| R1        | 8.2 kΩ | 0201 | Not critical       |
| R2        | DNI    |      |                    |
| R4        | 100 Ω  | 0201 | Not critical       |

#### Table 10. SKY67183-396LFEK2 Evaluation Board Bill of Materials (BOM) for 3400 to 3800 MHz Tuning

#### Table 11. SKY67183-396LFEK3 Evaluation Board Bill of Materials (BOM) for 2300 to 2700 MHz Tuning

| Component | Value  | Size | Part Number        |
|-----------|--------|------|--------------------|
| C1        | 5.0 pF | 0402 | GJM1555C1H5R0BB01D |
| C2        | 2.7 nH | 0402 | LQW15AN2N7B8ZD     |
| C3        | 0.4 pF | 0402 | GJM1555C1HR40WB01D |
| C4        | 10 pF  | 0402 | GRM1555C1H100JA01D |
| C5        | DNI    |      |                    |
| C6        | DNI    |      |                    |
| C7        | 4.7 uF | 0402 | GRM155C80J475MEAAD |
| C8        | 22 pF  | 0402 | GRM1555C1H220JA01  |
| C9        | 1.8 pF | 0402 | GRM1555C1H1R8BA01D |
| C10       | 3.3 nH | 0402 | LQG15HS3N3S02D     |
| C11       | DNI    |      |                    |
| C12       | DNI    |      |                    |
| L1        | 22 nH  | 0402 | LQW15AN22NG8ZD     |
| L2        | 5.6 nH | 0402 | LQG15HS5N6S02D     |
| R1        | 8.2 kΩ | 0201 | Not critical       |
| R2        | DNI    |      |                    |
| R4        | 100 Ω  | 0201 | Not critical       |

| Component | Value    | Size | Part Number        |
|-----------|----------|------|--------------------|
| C1        | 5.0 pF   | 0402 | GJM1555C1H5R0BB01D |
| C2        | 4.7 nH   | 0402 | LQW15AN4N7B8ZD     |
| C3        | 0.4 pF   | 0402 | GJM1555C1HR40WB01D |
| C4        | 15 pF    | 0402 | GRM1555C1H150JA01D |
| C5        | DNI      |      |                    |
| C6        | DNI      |      |                    |
| C7        | 4.7 uF   | 0402 | GRM155C80J475MEAAD |
| C8        | 22 pF    | 0402 | GRM1555C1H220JA01  |
| C9        | 1.8 pF   | 0402 | GRM1555C1H1R8BA01D |
| C10       | 6.2 nH   | 0402 | LQG15HS6N2S02D     |
| C11       | 300 Ohm  | 0402 | ERJ-2RKF3000C      |
| C12       | DNI      |      |                    |
| L1        | 22 nH    | 0402 | LQW15AN22NG8ZD     |
| L2        | 5.6 nH   | 0402 | LQG15HS5N6S02D     |
| R1        | 8.2 K0hm | 0201 | ERJ-1GNF8201C      |
| R2        | DNI      |      |                    |
| R4        | 100 Ohm  | 0201 | ERJ-1GNF1000C      |

Table 12. SKY67183-396LFEK4 Evaluation Board Bill of Materials (BOM) for 1700 to 2200 MHz Tuning

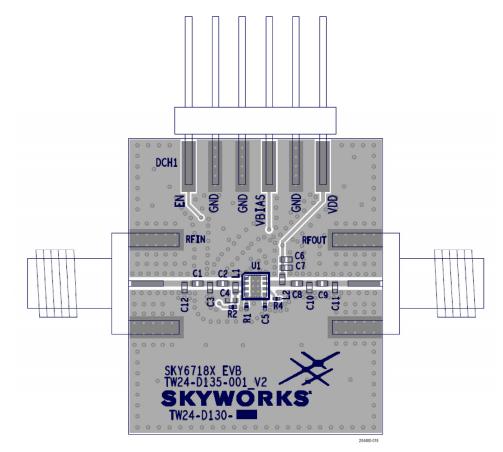


Figure 32. SKY67183-396LF EVB Assembly Diagram

|              |                         | тот           | AL THICKNESS | 1.578mm   | TOL: +/- 10%  |
|--------------|-------------------------|---------------|--------------|-----------|---------------|
| S=N/A        | CPW = N/A               |               | BMASK        | 0.020mm   | SOLDER RESIST |
| S=N/A        |                         |               | ∟4           | 0.047mm   | FINISHED Cu.  |
| W=N/A        | W=N/A                   | CORE          | DIELECTRIC   | 0.254mm   | FR4 (4.34)    |
|              |                         |               | L3           | 0.018mm   | Cu-0.5oz.     |
|              |                         | PREPREG       | DIELECTRIC   | 0.900mm   | FR4 (4.34)    |
|              |                         |               | L2           | 0.018mm   | Cu-0.5oz.     |
| 5=0.100mm    | CPW = 0.375mm           | CORE          | DIELECTRIC   | 0.254mm   | R04350B       |
| S=0.100mm    |                         |               | L1           | 0.047mm   | FINISHED Cu.  |
| W=0.301mm    | TOL: +/-5%<br>W=0.508mm |               | TMASK        | 0.020mm   | SOLDER RESIST |
| 50-OHM TRACE | 50-OHM TRACE            | CROSS SECTION | NAME         | THICKNESS | MATERIALS     |

Figure 33. SKY67183-396LF EVB Layer Details

204480-019

#### **Package Dimensions**

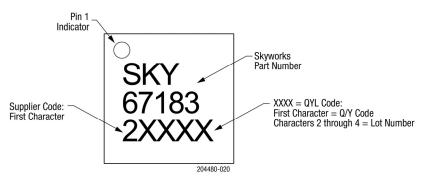
A typical part marking for the SKY67183-396LF is shown in Figure 34. The PCB layout footprint for the SKY67183-396LF is provided in Figure 35. Package dimensions are shown in Figure 36. Tape and reel dimensions are shown in Figure 37.

#### **Package and Handling Information**

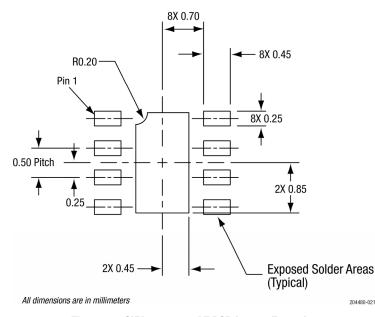
Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY67183-396LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

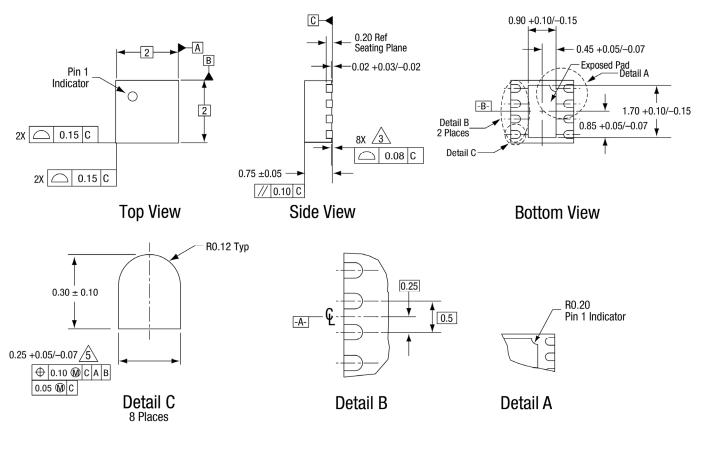
Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.











Notes:

1. All measurements are in millimeters.

2. Dimensions and tolerances according to ASME Y14.5M-1994.

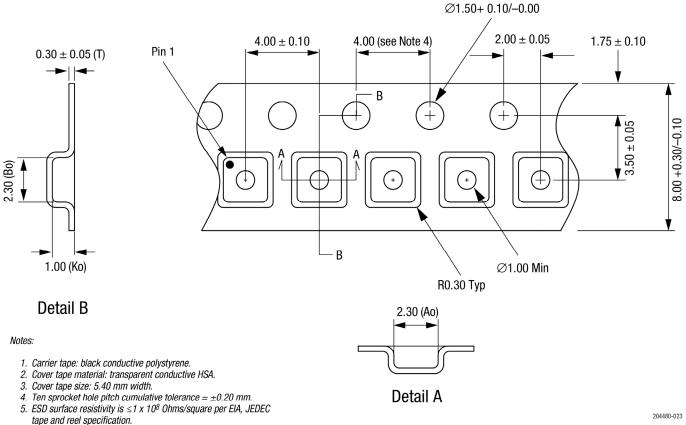
3. Coplanarity applies to the exposed heat sink ground pad as well as the terminals.

4. Plating requirement per source control drawing (SCD) 2504.

5. Dimension applies to metallized terminal and is measured between 0.15 mm and 0.30 mm from terminal tip.



204480-022



6. Ao and Bo measurement point to be 0.30 mm from bottom pocket.
7. All measurements are in millimeters.

#### Figure 37. SKY67183-396LF Tape and Reel Dimensions

#### **Ordering Information**

| Part Number     | Product Description                           | Evaluation Board Part Number            |  |
|-----------------|---|---|--|
|                 | 400 to 6000 MHz Broadband Low-Noise Amplifier | SKY67183-396EK1 (4.2 to 4.9 GHz Tuning) |  |
| SKY67183-396LF  |   | SKY67183-396EK2 (3.4 to 3.8 GHz Tuning) |  |
| SK107 103-390LF |   | SKY67183-396EK3 (2.3 to 2.7 GHz Tuning) |  |
|                 |   | SKY67183-396EK4 (1.7 to 2.2 GHz Tuning) |  |

Copyright © 2021 Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks Terms and Conditions of Sale.

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of stated published specifications or parameters.

Skyworks and the Skyworks symbol are trademarks or registered trademarks of Skyworks Solutions, Inc. or its subsidiaries in the United States and other countries. Third-party brands and names are for identification purposes only, and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference.